

Model:

LaserBase MF5730

LaserBase MF5750

LaserBase MF5770

Ref No.:

MFP-004

(SH-T01-0LD-10043-01)

Date:

March 2006

Location:

SCNT Board Assembly

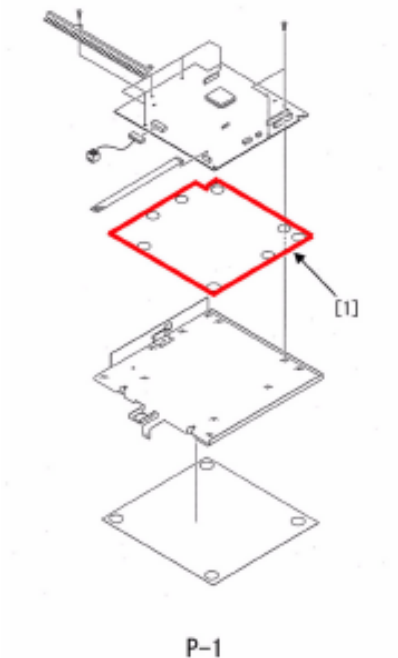
Subject:

Deletion of insulation sheet under the SCNT board assembly

Detail:

Due to the productivity, insulating sheet [1] under SCNT board assembly is removed.

There would be no problem even the insulating sheet is removed because the length of components under the SCNT board assembly, and a bend of SCNT board assembly and sheet metal have been already checked for the production.



P-1 SCNT BOARD ASSEMBLY

[1] Insulating sheet to be removed

Service parts:

The insulating sheet is not set as a service part.

Serial No.:

LaserBase MF5730 (GB) SFB03377 and later
LaserBase MF5750 (GB) SFC03441 and later
LaserBase MF5770 (GB) SFD02401 and later
LaserBase MF5730 (DE) SFE04813 and later
LaserBase MF5750 (DE) SFF03825 and later
LaserBase MF5770 (DE) SFG03214 and later
LaserBase MF5750 (FRN) SFJ04010 and later
LaserBase MF5770 (FRN) SHB02977 and later
LaserBase MF5730 (EUR) SFK06209 and later
LaserBase MF5750 (EUR) SFL08100 and later
LaserBase MF5770 (EUR) SFM06761 and later